# **Schottky Barrier Diode**

Schottky barrier diodes are optimized for very low forward voltage drop and low leakage current and are used in a wide range of dc-dc converter, clamping and protection applications in portable devices. NSR0620P2 in a SOD-923 miniature package enables designers to meet the challenging task of achieving higher efficiency and meeting reduced space requirements.

#### **Features**

- Very Low Forward Voltage Drop 350 mV @ 100 mA
- Low Reverse Current 2.0 μA @ 10 V
- Continuous Forward Current 500 mA
- Power Dissipation with Minimum Trace 190 mW
- Very High Switching Speed 4.0 ns @ 10 mA
- Low Capacitance 12 pF @ 1.0 V
- This is a Pb-Free Device

# **Typical Applications**

- LCD and Keypad Backlighting
- Camera Photo Flash
- Buck and Boost dc-dc Converters
- Reverse Voltage and Current Protection
- Clamping & Protection

### **Markets**

- Mobile Handsets
- MP3 Players
- Digital Camera and Camcorders
- Notebook PCs & PDAs
- GPS

# **MAXIMUM RATINGS**

| Rating  | Symbol           | Value               | Unit |
|---|------------------|---------------------|------|
| Reverse Voltage                               | V <sub>R</sub>   | 20                  | Vdc  |
| Forward Continuous Current (DC)               | IF               | 500                 | mA   |
| Non-Repetitive Peak Forward Surge<br>Current  | I <sub>FSM</sub> | 1.0                 | Α    |
| ESD Rating: Human Body Model<br>Machine Model | ESD              | Class 3B<br>Class C |      |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



# ON Semiconductor®

http://onsemi.com

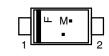
# 20 V SCHOTTKY BARRIER DIODE





SOD-923 CASE 514AB PLASTIC





F = Specific Device Code

= Month Code

= Pb-Free Package

(Note: Microdot may be in either location)

### ORDERING INFORMATION

| De    | evice   | Package              | Shipping†                      |
|-------|---------|----------------------|--------------------------------|
| NSR06 | 20P2T5G | SOD-923<br>(Pb-Free) | 2 mm Pitch<br>8000/Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

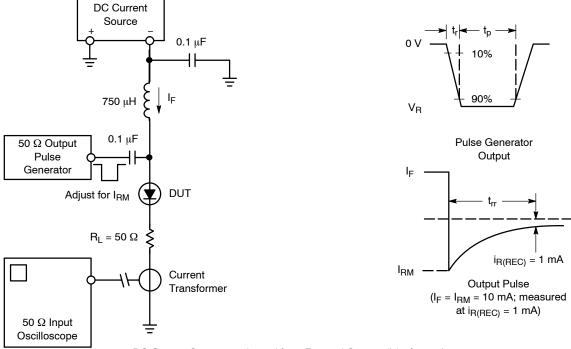
# THERMAL CHARACTERISTICS

| Characteristic  | Symbol   | Max         | Unit       |
|---|--|-------------|------------|
| Thermal Resistance Junction-to-Ambient (Note 1) Total Power Dissipation @ T <sub>A</sub> = 25°C | $egin{array}{c} R_{	hetaJA} \ P_D \end{array}$ | 520<br>190  | °C/W<br>mW |
| Thermal Resistance Junction-to-Ambient (Note 2) Total Power Dissipation @ T <sub>A</sub> = 25°C | R <sub>θJA</sub><br>P <sub>D</sub>             | 175<br>570  | °C/W<br>mW |
| Junction and Storage Temperature Range  | T <sub>J</sub> , T <sub>stg</sub>              | -55 to +125 | °C         |

- Mounted onto a 4 in square FR-4 board 10 mm sq. 1 oz. Cu 0.06" thick single-sided. Operating to steady state.
   Mounted onto a 4 in square FR-4 board 1 in sq. 1 oz. Cu 0.06" thick single-sided. Operating to steady state.

# **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

| Characteristic  | Symbol          | Min | Тур               | Max               | Unit |
|---|-----------------|-----|-------------------|-------------------|------|
| Reverse Leakage<br>(V <sub>R</sub> = 10 V)<br>(V <sub>R</sub> = 20 V)                                 | I <sub>R</sub>  |     | 2.0<br>9.0        | 10                | μΑ   |
| Forward Voltage<br>(I <sub>F</sub> = 10 mA)<br>(I <sub>F</sub> = 100 mA)<br>(I <sub>F</sub> = 500 mA) | V <sub>F</sub>  |     | 270<br>350<br>480 | 310<br>390<br>520 | mV   |
| Total Capacitance (V <sub>R</sub> = 1.0 V, f = 1 MHz)   | СТ              |     | 12                |                   | pF   |
| Reverse Recovery Time<br>(I <sub>F</sub> = I <sub>R</sub> = 10 mA, I <sub>R</sub> = 1.0 mA)           | t <sub>rr</sub> |     | 4.0               |                   | ns   |

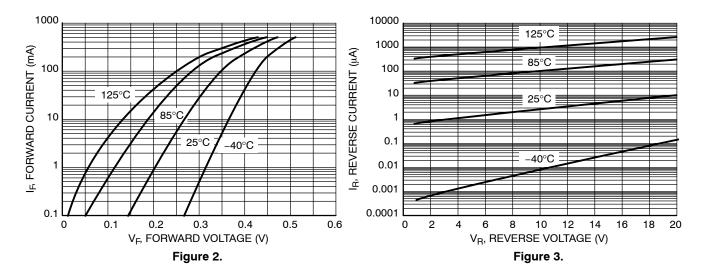


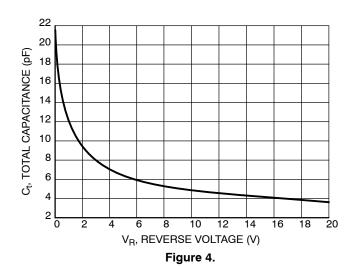
- 1. DC Current Source is adjusted for a Forward Current (I<sub>F</sub>) of 10 mA.
- Pulse Generator Output is adjusted for a Peak Reverse Recovery Current I<sub>RM</sub> of 10 mA.
- 3. Pulse Generator transition time << t $_{rr}$ .

  4.  $I_{R(REC)}$  is measured at 1 mA. Typically 0.1 X  $I_{RM}$  or 0.25 X  $I_{RM}$ .

  5.  $t_p$  »  $t_{rr}$

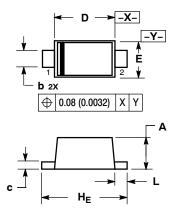
Figure 1. Recovery Time Equivalent Test Circuit





### PACKAGE DIMENSIONS

SOD-923 CASE 514AB-01 **ISSUE B** 

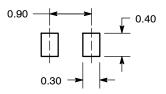


#### NOTES

- DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETERS.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL

|     | MILLIMETERS |      |      | INCHES |       |       |
|-----|-------------|------|------|--------|-------|-------|
| DIM | MIN         | NOM  | MAX  | MIN    | MON   | MAX   |
| Α   | 0.34        | 0.37 | 0.40 | 0.013  | 0.015 | 0.016 |
| b   | 0.15        | 0.20 | 0.25 | 0.006  | 0.008 | 0.010 |
| С   | 0.07        | 0.12 | 0.17 | 0.003  | 0.005 | 0.007 |
| D   | 0.75        | 0.80 | 0.85 | 0.030  | 0.031 | 0.033 |
| E   | 0.55        | 0.60 | 0.65 | 0.022  | 0.024 | 0.026 |
| HE  | 0.95        | 1.00 | 1.05 | 0.037  | 0.039 | 0.041 |
| L   | 0.05        | 0.10 | 0.15 | 0.002  | 0.004 | 0.006 |

#### **SOLDERING FOOTPRINT\***



**DIMENSIONS: MILLIMETERS** 

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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